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866

PATENT NUMBER and  
ISSUE DATE

U.S. UTILITY Patent Application

10/03/02  
01/08/02

APPL NUM 10043724	FILING DATE 01/08/2002	CLASS 438	SUBCLASS 28	GAU 2842	EXAMINER H. Lee
<b>**APPLICANTS:</b> Lee Kang-Yoon;					
<b>**CONTINUING DATA VERIFIED:</b> NONE Lee					
<b>** FOREIGN APPLICATIONS VERIFIED:</b> Lee REPUBLIC OF KOREA 01-1892 01/12/2001 Yes					
PG-PUB <input type="checkbox"/>		DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>	
Foreign priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no Verified and Acknowledged Examiners's initials Lee				ATTORNEY DOCKET NO 9898-201	
TITLE : Method of forming semiconductor device having contact pad on source/drain region in peripheral circuit area					

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)

<b>NOTICE OF ALLOWANCE MAILED</b>		<b>CLAIMS ALLOWED</b>	
		Total Claims	Print Claim for O.G.
<b>ISSUE FEE</b>		<b>DRAWING</b>	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg. Print Fig.
<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>		<b>Application Examiner</b>	
		<b>PREPARED FOR ISSUE</b>	
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